

Features

- Average Forward Current: $I_{F(AV)}=3A$
- Polarity: Color band denotes cathode



SMC
(DO-214AB)



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
SS32C-SS310C	SMC (DO-214AB)	SS3x	3000

x:From 2-10

Maximum Ratings (Ta=25°C unless otherwise noted)

Item	Symbol	Unit	Test Conditions	SS3							
				2	3	4	5	6	8	9	10
Repetitive Peak Reverse Voltage	V _{RRM}	V		20	30	40	50	60	80	90	100
MaximumRMS Voltage	V _{RMS}	V		14	21	28	35	42	56	63	70
Average Forward Current	I _{F(AV)}	A	60Hz Half-sine wave, Resistance load, FIG.1	3.0							
Surge(Non-repetitive)Forward Current	I _{FSM}	A	60Hz Half-sine wave, 1 cycle, Ta=25℃	80							
Junction T emperature	T _J	℃		-55~+125			-55~+150				
Storage Temperature	T _{STG}	℃		-55 ~ +150							

Electrical Characteristics (Ta=25°C unless otherwise specified)

Item	Symbol	Unit	Test Condition		SS3							
					2	3	4	5	6	8	9	10
Peak Forward Voltage	V _F	V	I _F =3.0A		0.55			0.70		0.85		
Peak Reverse Current	I _{RRM1}	mA	V _{RM} =V _{RRM}	Ta=25℃	0.1				0.02			
	Ta=100℃			5				2				
Thermal Resistance(Typical)	R _{θJ-A}	℃/ W	Between junction and ambient		60							
	R _{θJ-L}		Between junction and terminal		20							

Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.27" x 0.27" (7.0 mm x 7.0 mm)

Typical Characteristics

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

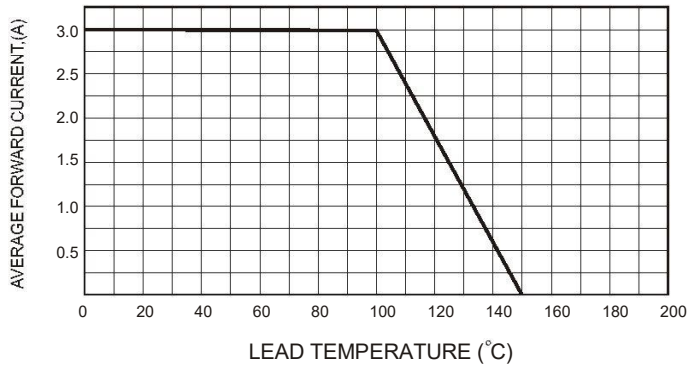


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

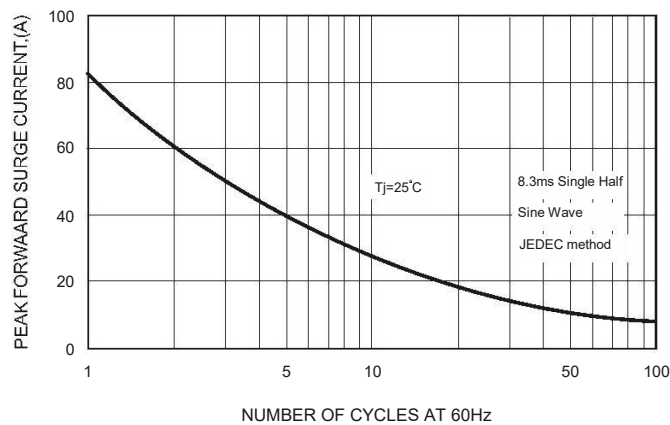


FIG.4-TYPICAL JUNCTION CAPACITANCE

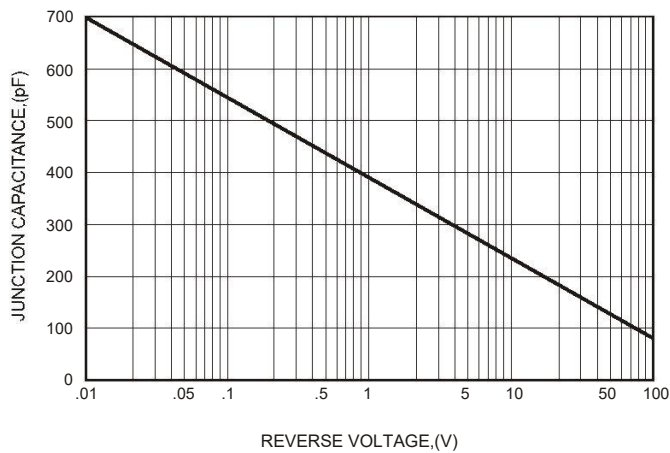


FIG.2-TYPICAL FORWARD CHARACTERISTICS

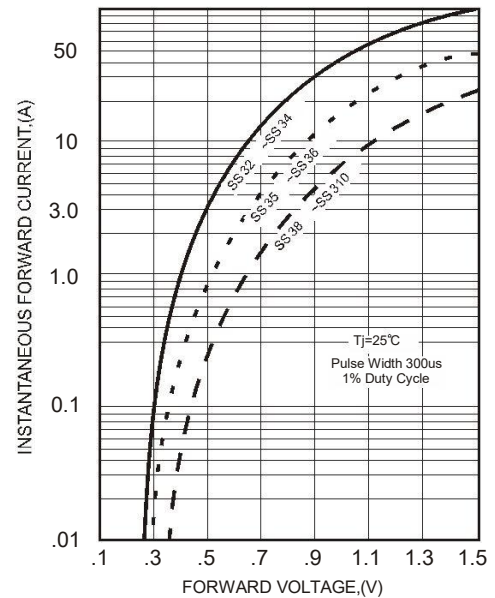
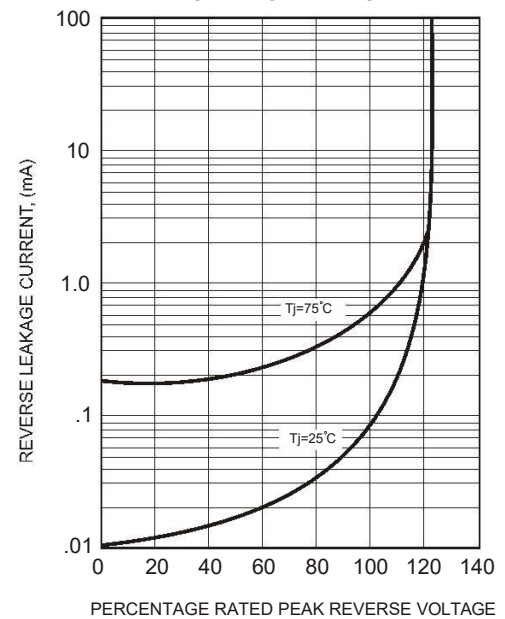
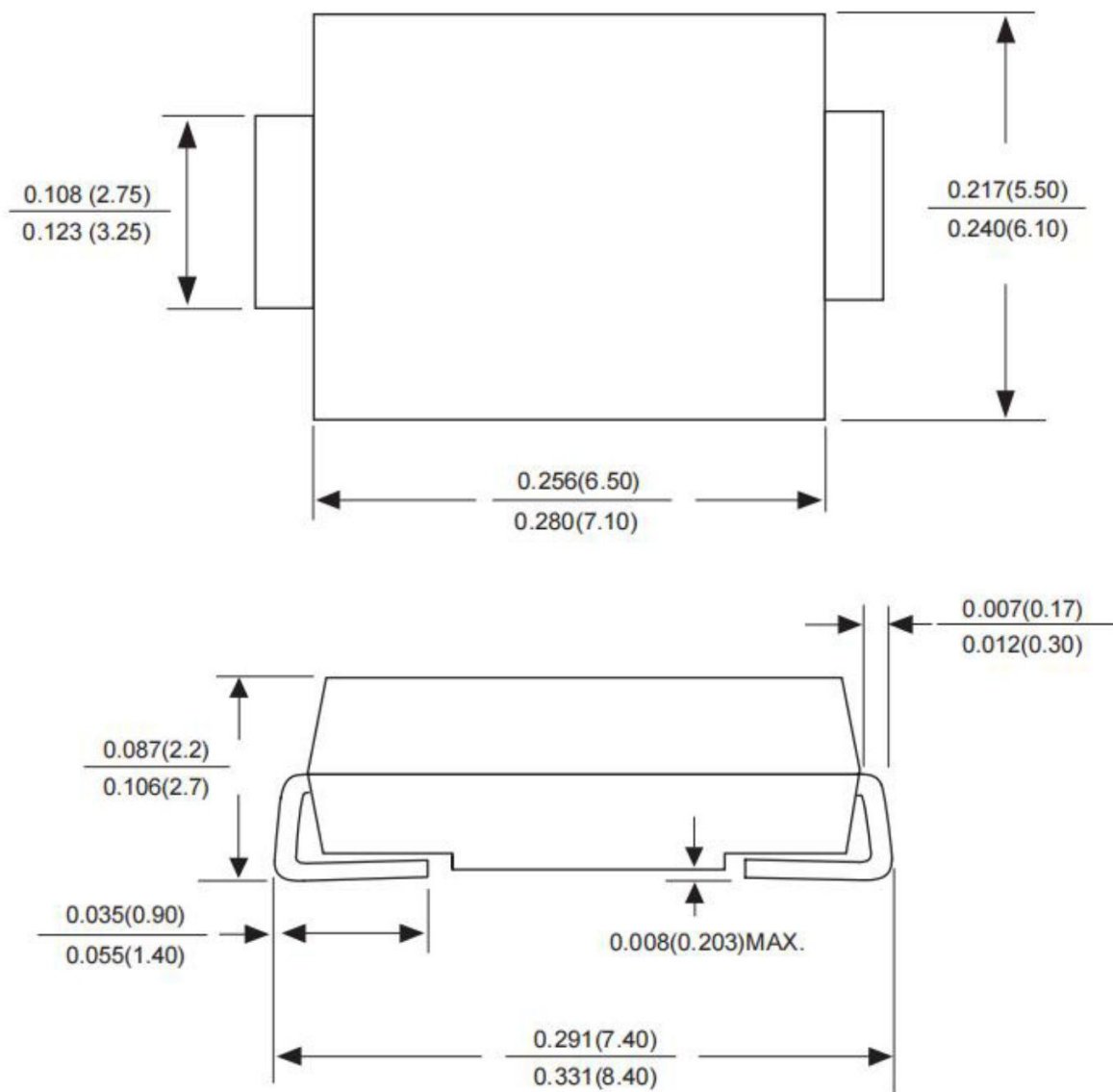


FIG.5 - TYPICAL REVERSE CHARACTERISTICS



Package Outline Dimensions

SMC(DO-214AB)



Dimensions in inches and (millimeters)

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